



Customer Information Notification

202507008I : S32E2 Data Sheet Update to Rev 6

Note: This notice is NXP Company
Proprietary.

Issue Date: Jul 22, 2025 **Effective Date:** Jul 23, 2025

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Change Category

- | | | | | |
|----------------------------------------------------|------------------------------------------------|----------------------------------------------------|--------------------------------------------|---------------------------------------------------------------|
| <input type="checkbox"/> Wafer
Fab
Process | <input type="checkbox"/> Assembly
Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test
Process | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer
Fab
Materials | <input type="checkbox"/> Assembly
Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test
Equipment | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer
Fab
Location | <input type="checkbox"/> Assembly
Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test
Location | <input type="checkbox"/> Electrical
spec./Test
coverage |
- ☐ Firmware ☒ Other: Data Sheet Update

Notification Overview

Description

NXP Semiconductors announces an update of Data Sheet for S32E2 devices associated with this notification.

The Data Sheet has been updated from Rev5 to Rev6.

The revision history included in the updated document provides a detailed description

of the changes.

The updated S32E2 Data Sheet is attached with this notification or can be found at:

<https://www.nxp.com/products/S32E2>

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02

Reason

The Data Sheet has been updated to provide additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No Impact on form, fit, function, reliability or quality

Data Sheet Revision

A new data sheet will be issued

Additional information

Additional documents: [view online](#)

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Support Tickets

Position NXP Support

**e-mail
address** <http://www.nxp.com/support>

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NXP Quality Management Team.

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